Study on infiltration of Copper-Indium Alloys and Corrosion Resistance of 304 Stainless Steel by Double Glow Technology

Xu jinyong¹, Wang yiguang¹, Hao jianmin², Tang Yan^{1a}

¹College of mechanical and electrical engineering, Guilin University of Electronic Technology, Guilin Guangxi 541004 China.
²School of mechanical engineering, Chang'an University, Xian Shanxi 710064 China.

Keywords: Double Glow Technology. 304 Stainless Steel. Corrosion Resistance.

Abstract. Copper-Indium alloys elements were metallized into 304 Stainless Steel surface by Double Glow Plasma Surface Alloying Technology (Double Glow Technology). Microstructure and Corrosion Resistance of diffusion layer analyzer was analysed by scanning electron microscopy, energy spectrum and electrochemical measuring instrument. The results show that process parameters of the permeability Copper-Indium had an obvious effect for the organization structure and performance of diffusion layer. Electrochemical corrosion tests were carried out in 1mol/L H2SO4 solution, 1mol/L NaOH solution, 3.5% NaCl solution. The matrix was 3.51 and 2.9 times faster compared with the 304 stainless steel sample of surfacing contained Copper-Indium alloys layer for relativing corrosion rate in 1mol/L NaOH solution, 3.5% NaCl solution, 3.5% NaCl solution. But, the 304 Stainless Steel sample of surfacing contained Copper-Indium alloys layer for relativing cortained Copper-Indium alloys layer was 1.21 times faster compared with matrix in 1mol/L H2SO4 solution.

1 Introduction

The main features of stainless steel were stainlessness and corrosion resistance. Since the invention of stainless steel, it had a well corrosion resistance and was widely used in food, national defense science and technology, chemical, oil and other industrial sectors. Although stainless steel had excellent corrosion resistance, under certain conditions, corrosion, wear or under certain adverse conditions and then accelerated the corrosion process and material damage and shorten its useful life [1-4]. Therefore, Copper-Indium alloy layer would affect the corrosion performance, it is necessary to discuss. Double Glow Technology is a kind of surfacing modification technology. It has energy saving, low pollution, low cost, simple operation, strong bonding force [5-7]b. Copper-Indium alloys elements were metallized into 304 Stainless Steel surface by Double Glow Technology, 304 Stainless Steel sample after infiltration and matrix divided electrochemical corrosion test in 1mol/L H2SO4 solution, 1mol/L NaOH solution, 3.5% NaCl solution. A corrosion capacity of the 304 Stainless Steel was analysised before and after Copper-Indium was infiltrated.

^a Corresponding author : Tang Yan, 1195957256@qq.com.

2 Experimental method

The source material used plate's Copper-Indium alloys. The quality percentage of Copper-Indium alloys for 5:5. No fixed desired size, as long as the source material could be placed in a graphite crucible. Cathode material was 304 Stainless Steel. Dimension was 40mm×20mm×2mm. Before the experiment, the surface of the 304 Stainless Steel sample was polished by 2000# sandpaper.

The initial Copper-Indium alloys process parameters on 304 Stainless Steel were as follows: Argon gas as a medium: Work Pressure:30~35 Pa; Source Voltage: -900V~-1000 V; Cathode Voltage: -600V~700 V; Heat Preservation: 4h; Workpiece heat preservation temperature is 900 °C with furnacing cooling. After infiltration Copper-Indium the 304 Stainless Steel was etched for aqua regia. The sample was preparated by LD-10KW plasma surface alloying. Nitrided layer was observed by SEM. Nitrided layer element distribution was detected by EDS.

The experiment used PS-268A electrochemical measuring instrument. Matrix and 304 Stainless Steel sample of the infiltration of Copper-Indium elements divided electrochemical corrosion test in 1mol/L H2SO4 solution, 1mol/L NaOH solution, 3.5% NaCl solution. Specific test procedure is as follows:

(1)Samples were cutted out 10 mm×10 mm specimen of corrosion by Metallographic cutter.

(2)The beaker was placed in stable work surface as a corrosion solution and into the etching solution.

(3)The auxiliary electrode, working electrode, and a reference electrode were fixed respectively well.

(4)After the samples were etched solution to be 30 min, opening software installed, and the process was activated.

After the relevant parameters were setted up, corrosion polarization curve was worked.

3 Experimental results and analysis

3.1 Sectional morphology and composition of the Copper-Indium alloy layer

Figure 1 was a cross-section microstructure of infiltration of the 304 Stainless Steel was taken into picture for using SEM. Alloy diffusion layer consisted of layer deposition and diffusion layer, the diffusion layer thickness was 35μ m. You can see from the chart, no voids between the diffusion layer and the substrate, they had a good combination of properties.

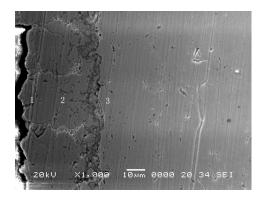


Figure 1. Microstructure of diffusion layer

As can be understood from Fig.1, the surface of the alloy coating penetration was consisted of deposited layer, diffusion layer of the containing Copper-Indium elements and the substrate. From the figure it was clear that there was a clear over the area between the substrate and the diffusion layer, C contain of 0.95% at 3, much higher than the amount of C of the substrate. After analysis of observation, this was because some austenite transformed into a ferrite in high temperatures, pearlite thus produced, and the formation of a diffusion layer of dark bands. Cause in the skin layer Copper content was relatively high because the bombardment of high-energy particles of the iron atom was charged sputtered out of the matrix in the surface matrix, such that the surface layer resulted in vacancy defect concentration gradient, Copper atoms which a source bombardment were reached to the surface just to fill this vacancy in the delivery of energy. The lower levels of the Indium element reason was because the radius of Indium atoms is 144 pm, and the iron atom atomic radius is 126 pm, little difference the radius and the main form of interstitial solid solution exists. Higher Copper content of the reason is because the atomic radius of the Copper atoms is 128 pm and the atomic radius of iron atoms is very close to 126 pm at a high temperature, Copper displaced the iron atom forms exist in matrix. Therefore, the Copper ions diffused deeper than Indium ions.

3.2 Phase of the Copper-Indium alloy layer

Figure 2 was based on the experimental diagram optimum process, the X-ray picture of the surface of the 304 Stainless Steel content of coating penetration of Copper-Indium alloy was prepared. Seen from the figure, the main phases of the alloy coating penetration were: Fe, Cu, Cu7In3, Cr6Fe18Mn5, In2O3, CuO, CCuO3 and so on. The surface of the alloy layer contained a large number of Copper ions. one hand, because of the the Copper atoms of some solid solution continuoued accumulation, precipitation of Copper ions of diffusing shaped. On the other hand, since the source was sputtered out a large number of Copper of the reactive ionic groups, part of the Copper ions did not diffuse into the substrate interior, while the surface deposition.

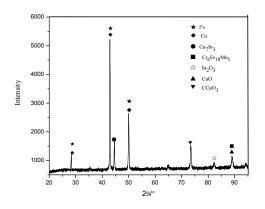


Figure 2 .Nitrided layer surface X-ray diffraction diagrams

3.3 Results and analysis of corrosion in 3.5% NaCl solution

As shown in Figure 3: The treated 304 Stainless Steel was prepared with baseing on this experiment optimum parameters and the matrix were E-log i curves in 3.5% NaCl solution.

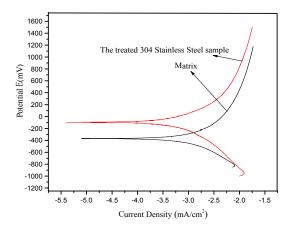


Figure 3. E-log i curve of the treated 304 Stainless Steel and the matrix in 3.5% NaCl solution

As can be seen from Figure 3, 304 Stainless Steel sample of the surface contained of Copper-Indium alloy coating penetration and substrates had appeared with increasing of polarization potential of corrosion, corrosion current density were both followed reduced in cathodic polarization phase. When the potential was rose to -397mV, matrix began to take the lead into the anodic polarization stage compared to the treated 304 Stainless Steel sample. When the potential was risied to 1100 mV, corrosion current density was gradually stabilize. At this time, Matrix began to the passive region, and when the potential was rose to -100mV, the treated 304 Stainless Steel began to enter the anodic polarization stage. When the potential was raised to 1450mV, the treated 304 Stainless Steel began to enter the passive range. Corrosion potential of the treated 304 Stainless Steel sample than the corrosion potential of the matrix to improve 297mV, from point of view of the thermodynamics, the treated 304 Stainless Steel sample was more corrosion resistance than the matrix in 3.5% NaCl solution.

3.4 Results and analysis of corrosion in 1mol/L H₂SO₄ solution

As shown in Figure 4: The treated 304 Stainless Steel was prepared with baseing on this experiment optimum parameters and the matrix were E-log i curves in 1 mol/L H2SO4 solution.

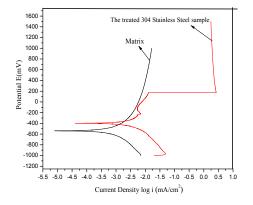


Figure 4. E-log i curve of the treated 304 Stainless Steel and the matrix in 1 mol/L H₂SO₄ solution

As can be seen from Figure 4, the treated 304 Stainless Steel sample and the matrix had appeared with increasing of polarization potential of corrosion, corrosion current density were both followed reduced in cathodic polarization phase. When the potential was rose to -539mV, the treated 304 Stainless Steel sample began to take the lead into the anodic polarization stage compared to matrix. At this time, with the further increased of the potential, the corrosion current density of the matrix was increased. When the potential was raised to 1000mV, the treated 304 Stainless Steel sample began to take the lead into the anodic polarization stage compared to matrix. At this time, with the potential was raised to 1000mV, the treated 304 Stainless Steel sample began to take the lead into the passive region. Passivation film was gradually thickened, the corrosion current density of the treated 304 Stainless Steel sample was 0.00827mA·cm⁻². The same to the matrix, the potential was raised to -399mV, the matrix began to enter the anodic polarization stage, and the corrosion current density was increased with increasing voltage. From point of view of the thermodynamics, corrosion tendency of the matrix even better than the treated 304 Stainless Steel sample in 1 mol/L H₂SO₄ solution. Howerer, after a very short range potential, when the potential was raised to -173mV, the matrix began to enter the passive region, which also showed the matrix was formed on stability of the passive film no better than the treated 304 Stainless Steel sample. After the matrix was entered the passive region, the corrosion current density was 0.00679mA·cm⁻². A

3.5 Results and analysis of corrosion in 1mol/L NaOH solution

As shown in Figure 5: The treated 304 Stainless Steel sample was prepared with baseing on this experiment optimum parameters and the matrix were E-log i curves in 1 mol/L H2SO4 solution.

As can be seen from Figure 5, the treated 304 Stainless Steel sample and the matrix had appeared with increasing of polarization potential of corrosion, corrosion current density were both followed reduced in cathodic polarization phase. When the potential was raised to -229 mV, the matrix began to take the lead into the anodic polarization stage compared to the treated 304 Stainless Steel sample. Then the potential was continued to rise, the matrix was showed its instability, it showed that the production process of the passivation film was unstable, when the potential was rose to 209 mV, the matrix began to enter the anodic polarization stage when the potential was rose to -162 mV.

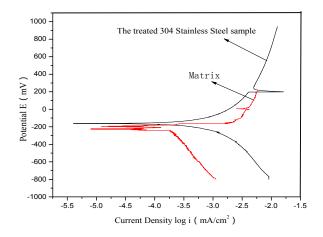


Figure 5. E-log i curve of the treated 304 Stainless Steel and the matrix in 1 mol/L NaOH solution

From point of view of the thermodynamics, the treated 304 Stainless Steel sample was more corrosion resistance than the matrix in 1 mol/L NaOH solution. When the potentia was continued to rise, the corrosion current density was increased along. When the potential was rose to 944 mV, the treated 304

Stainless Steel sample began to enter the passive region. Corrosion current density of the treated 304 Stainless Steel sample and the matix were 0.0039mA·cm⁻² and 0.0137mA·cm⁻². From point of view of the kinetic, the treated 304 Stainless Steel sample was more corrosion resistance than the matrix in 1 mol/L NaOH solution.

4 Conclusions

(1) The diffusion layer thickness the surface of the 304 Stainless Steel of penetration Copper-Indium alloy had about 35μ m, diffusion layer uniform density, diffusion layer of combining with well.

(2) The matrix was 3.51 and 2.9 times faster compared with the treated 304 Stainless Steel sample in 1mol/L NaOH solution, 3.5% NaCl solution. But, the 304 Stainless Steel sample of surfacing contained Copper-Indium alloys layer was 1.21 times faster compared with matrix in 1mol/L H2SO4 solution.

Acknowledgement

It is a project supported by the National Natural Science Foundation of China (51361008).

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